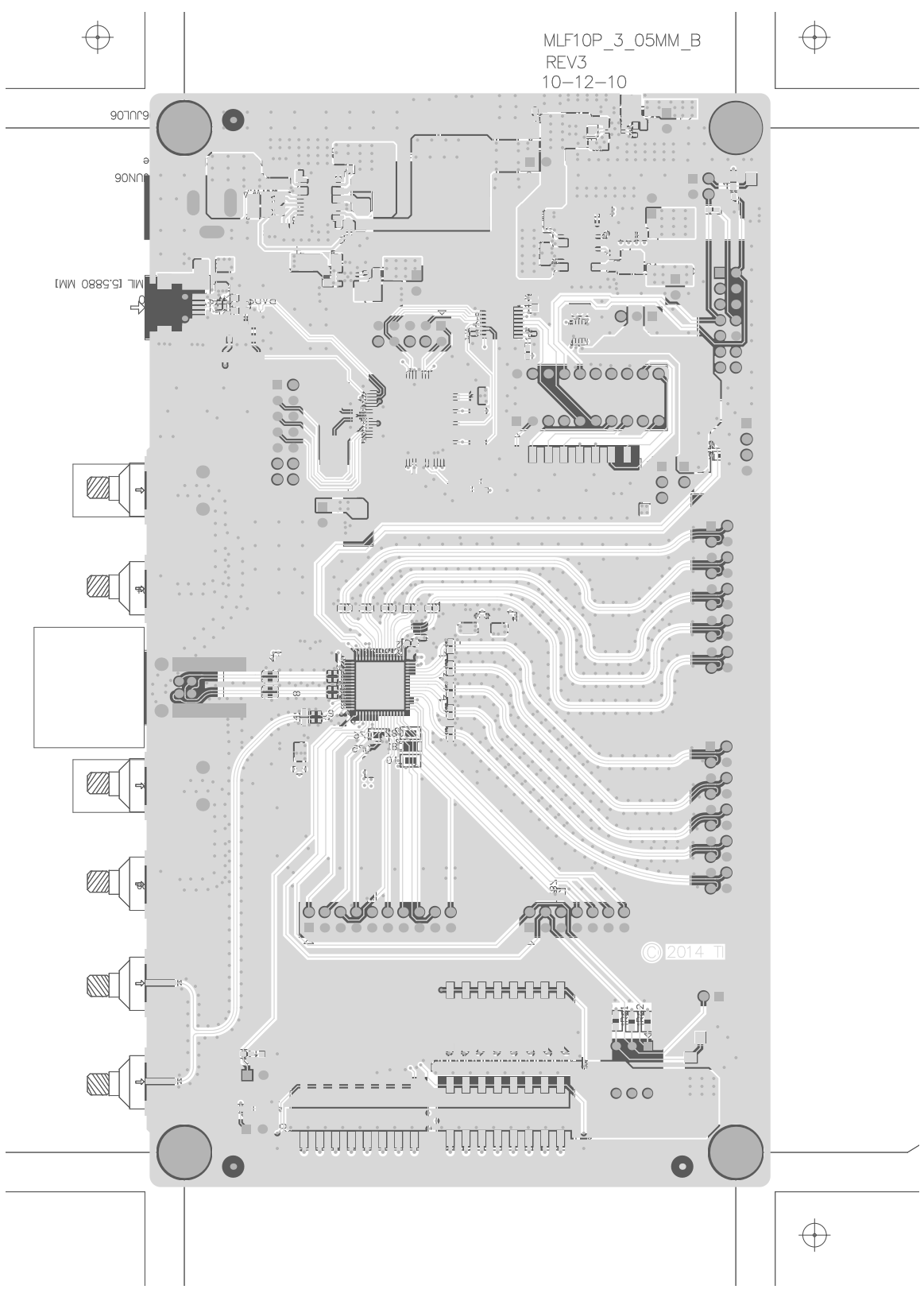


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REV3  
10-12-10



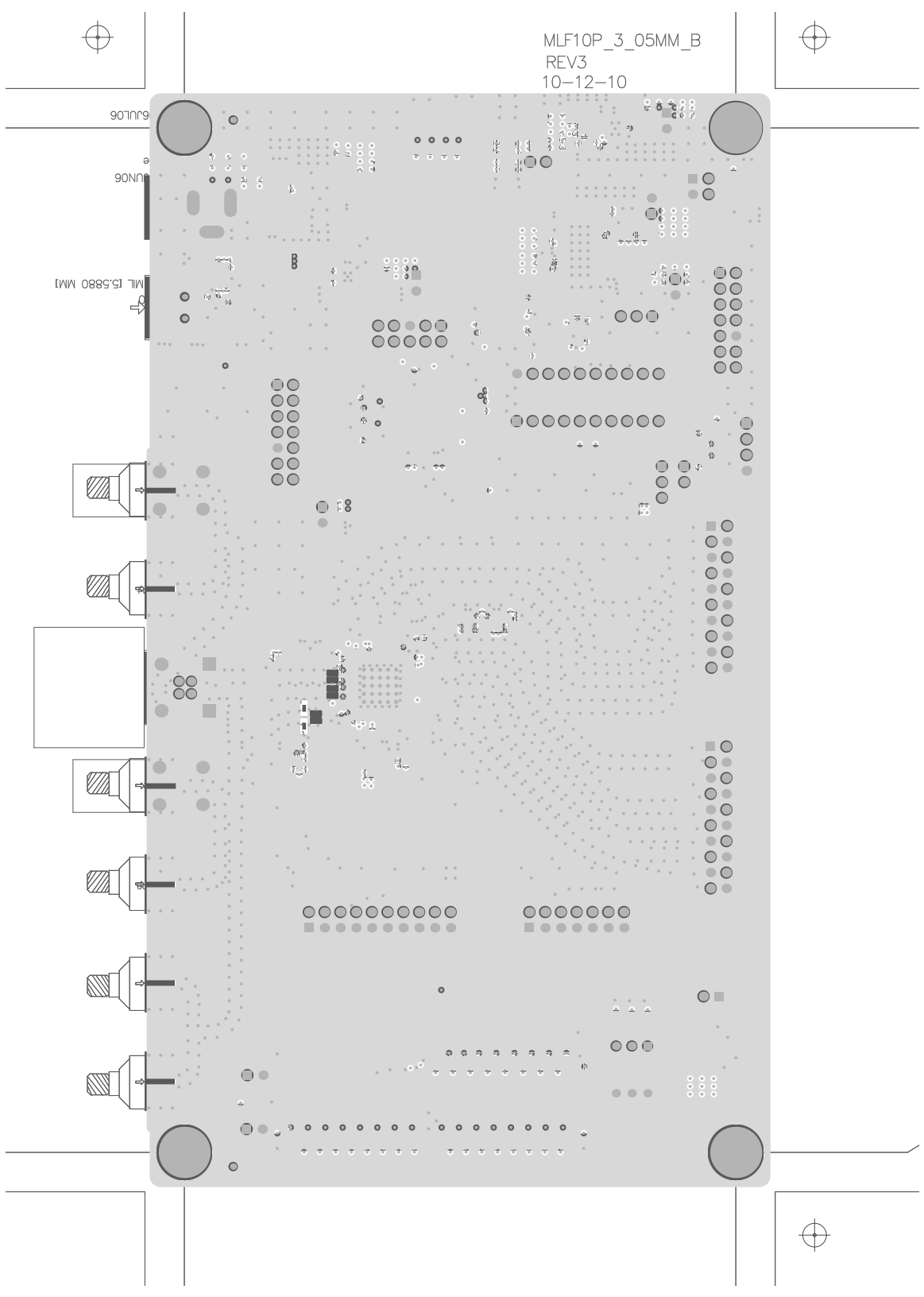
ML (5.880 MM)

90UN06

90UN06

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MLF10P\_3\_05MM\_B  
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10-12-10

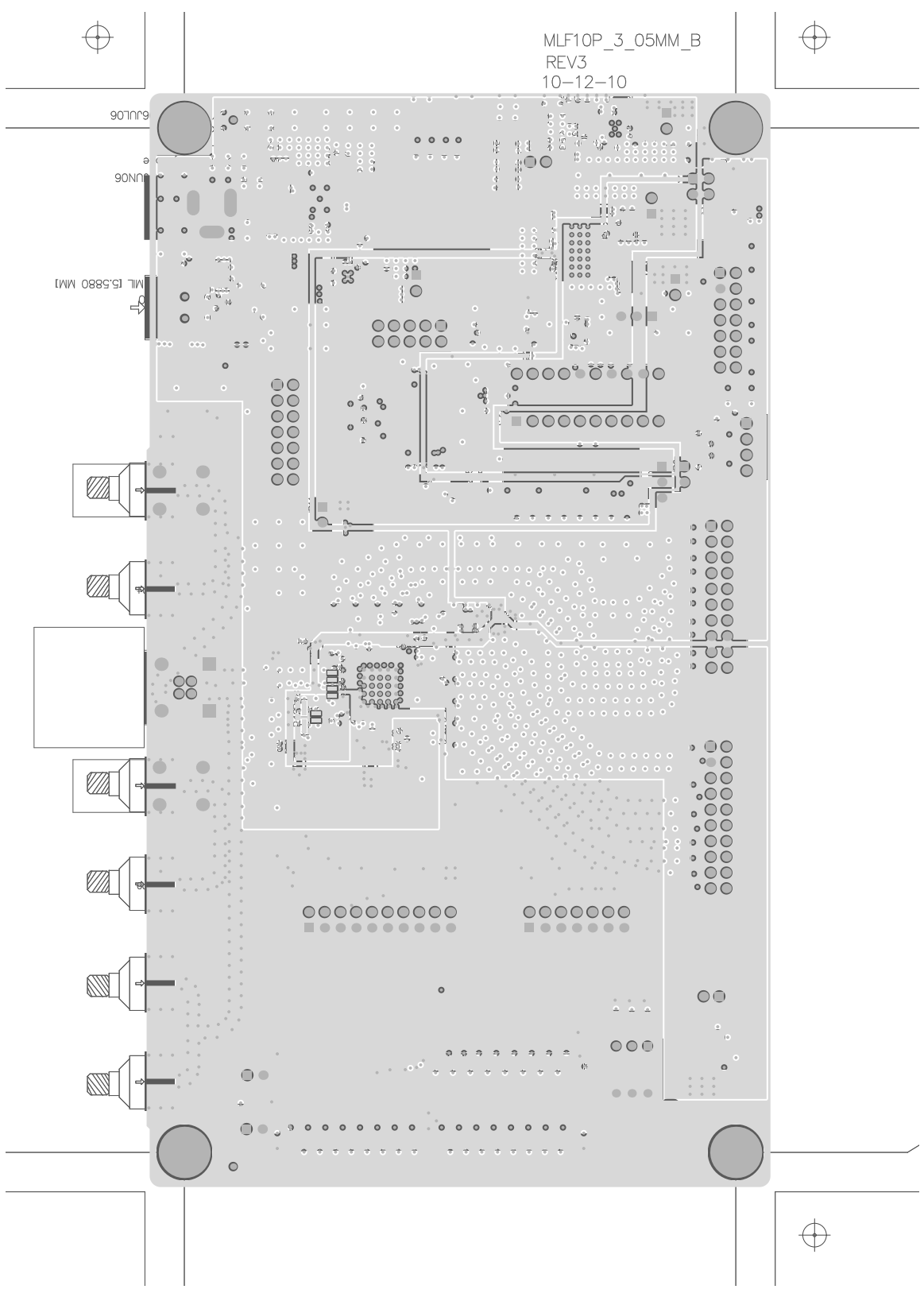


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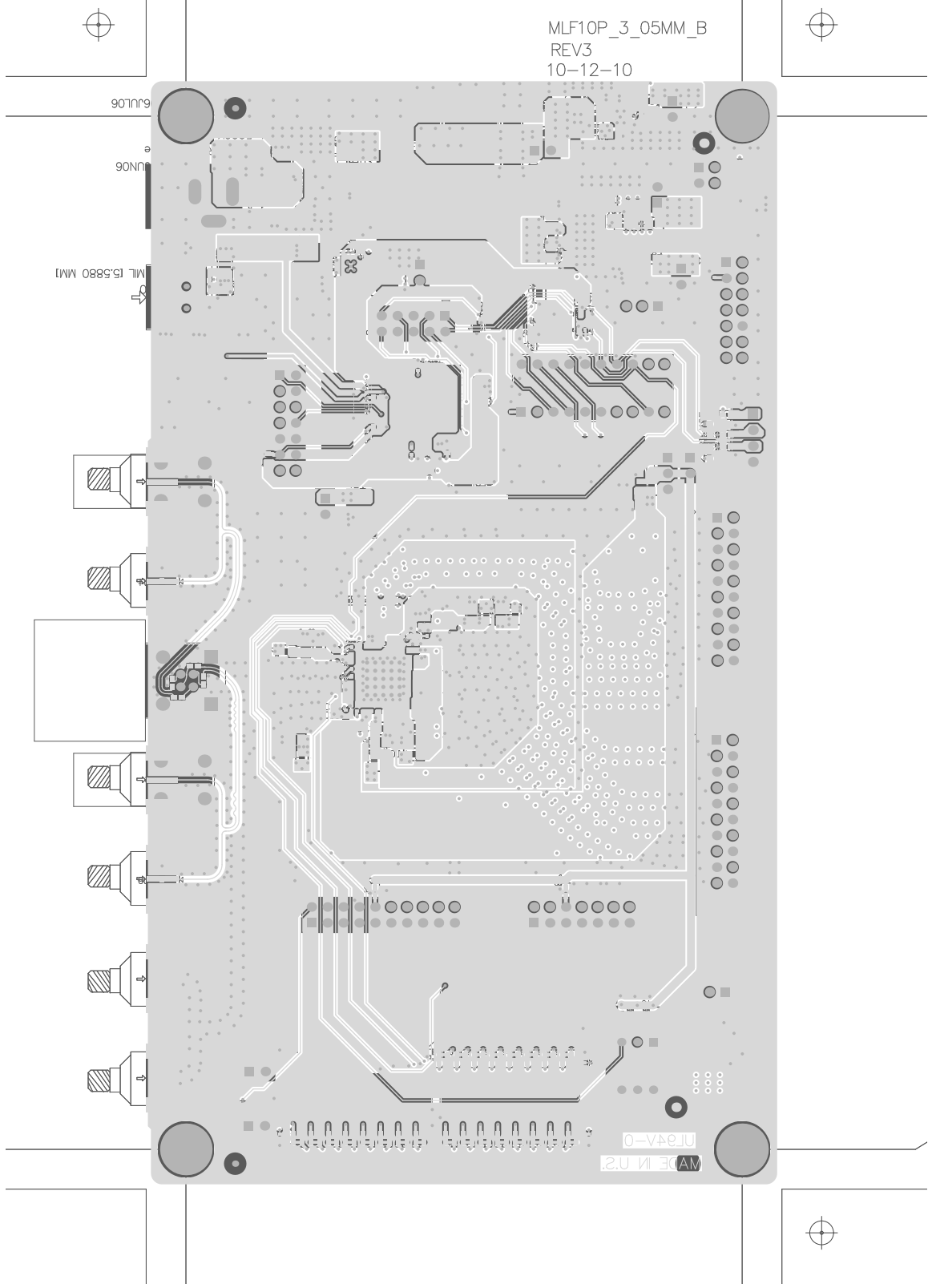
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ML [5,5880 MM]

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REV3  
10-12-10



MLF10P\_3\_05MM\_B  
REV3  
10-12-10



90UN06

90UN06

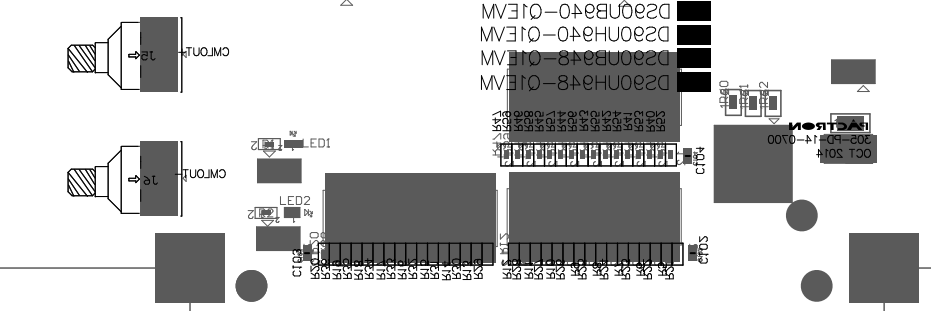
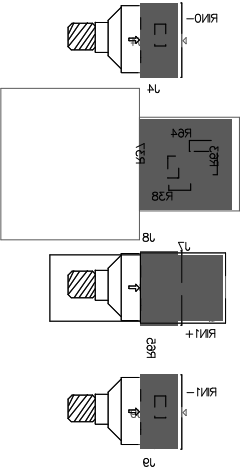
ML (5.5880 MM)

U104V-0  
MADE IN U.S.



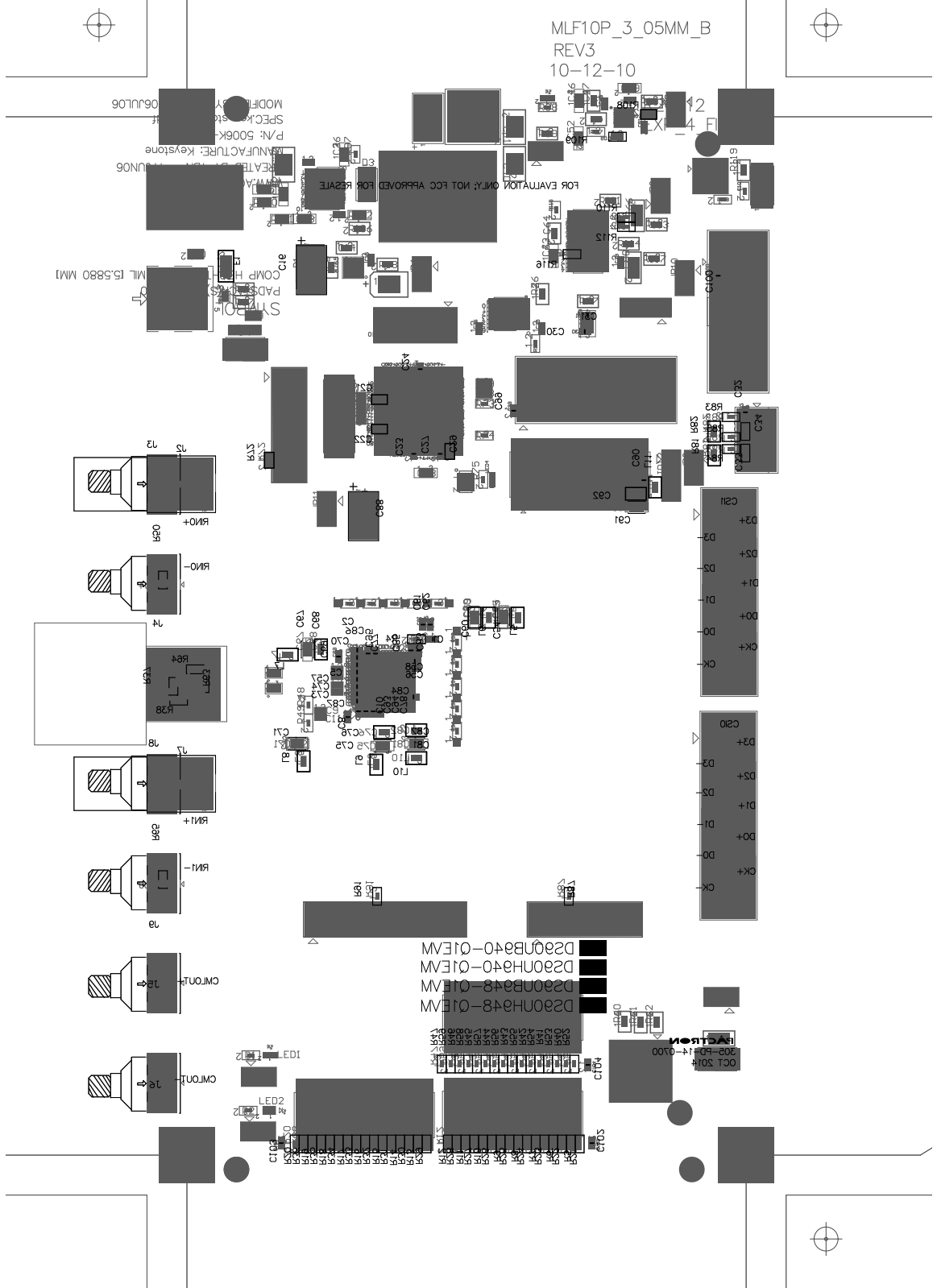
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REV3  
10-12-10

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P/N: 5006K  
MANUFACTURE: Keystone  
REVISION: [REDACTED]

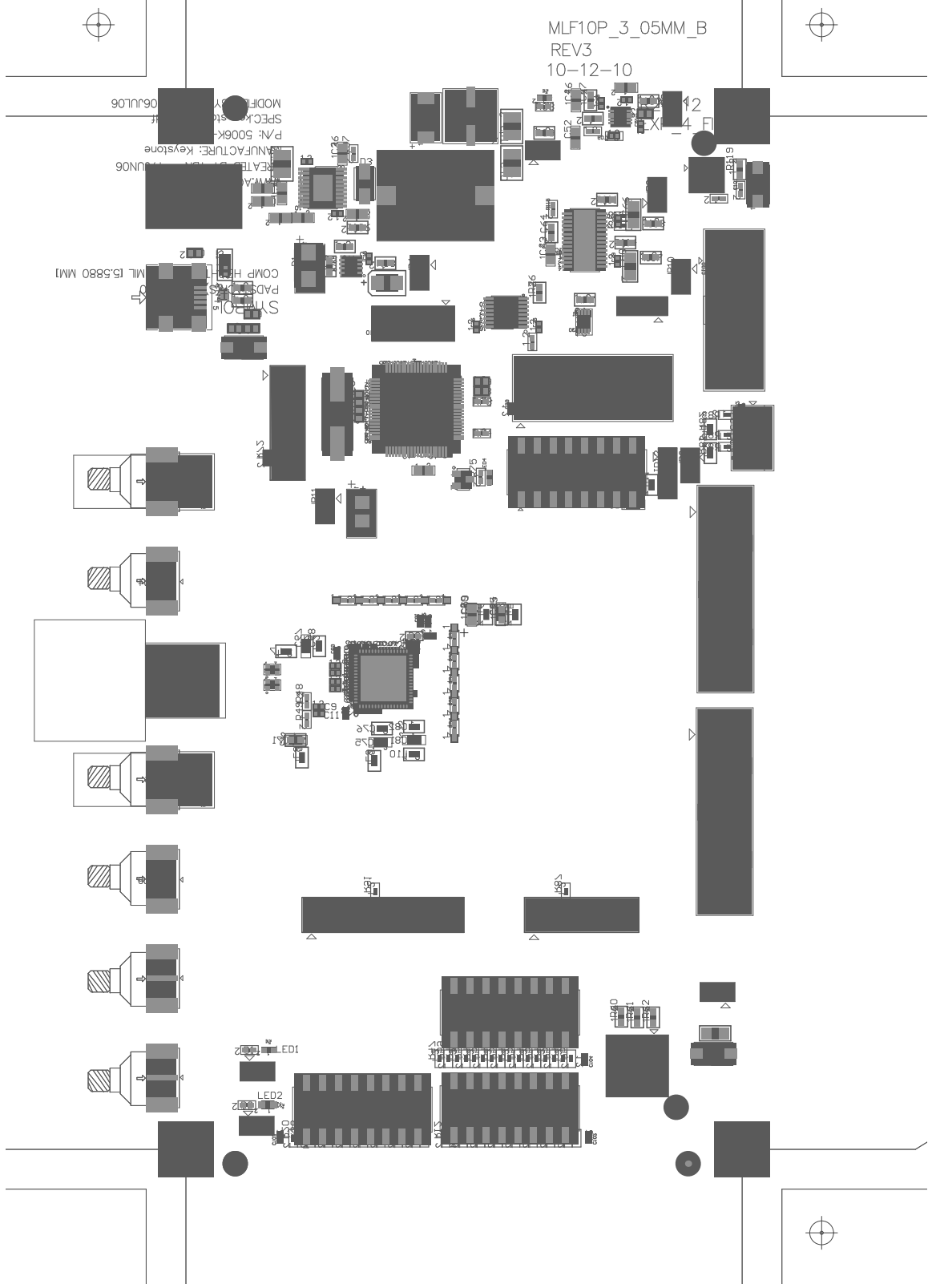


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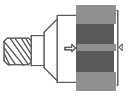
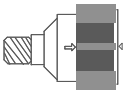
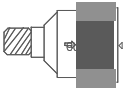
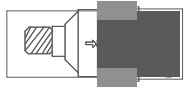
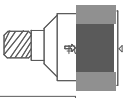
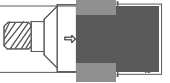


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REV3  
10-12-10

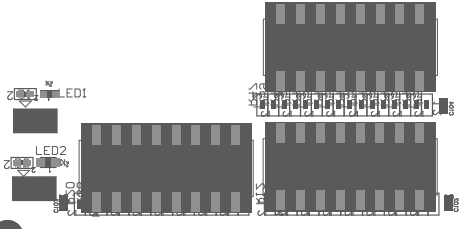


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P/N: 5006K  
SPEC: 0506K  
MODIFIED: 06JUL06

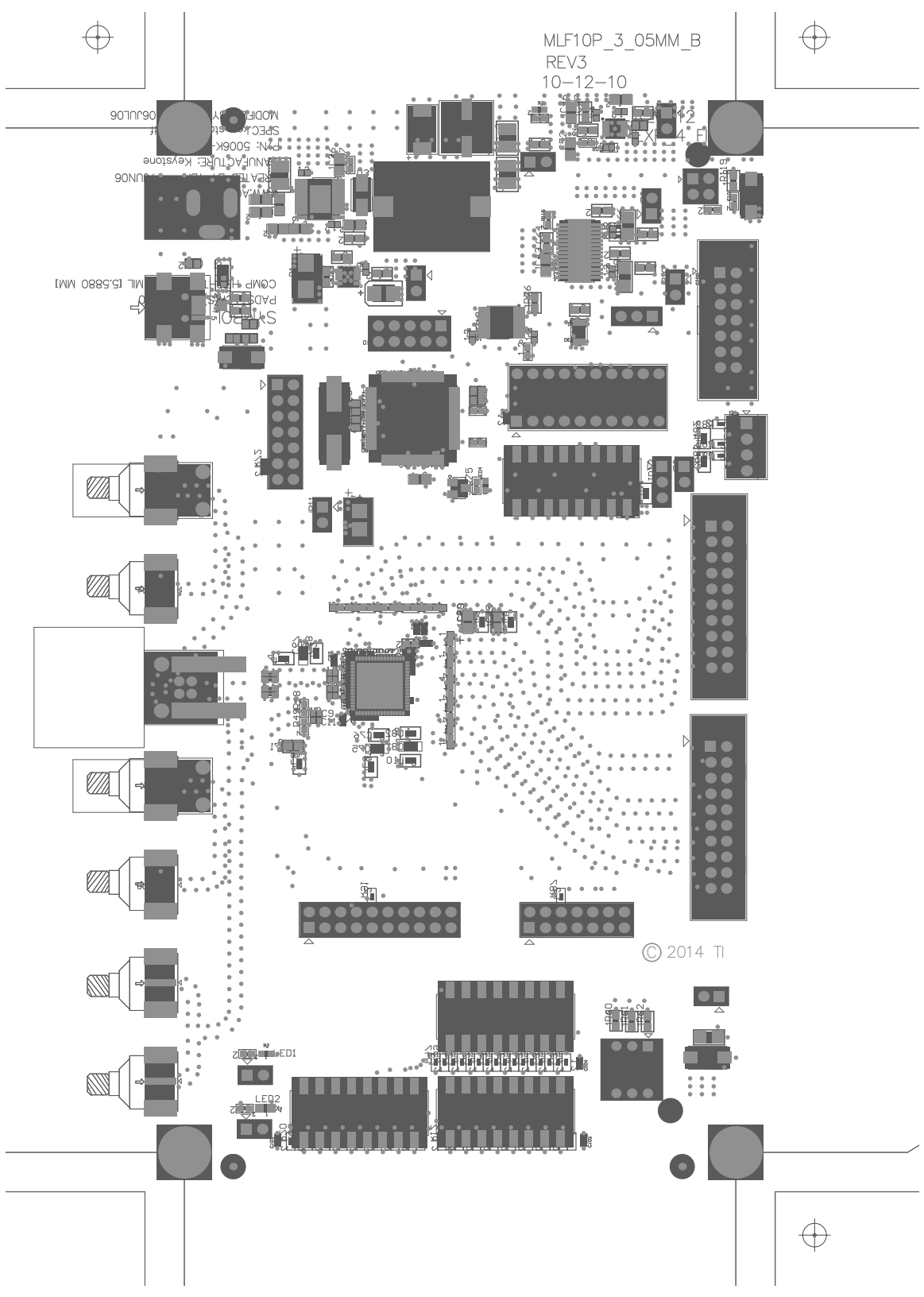
SYMBOLS  
PADS  
COMP H  
ML (5.5880 MM)



LED1  
LED2



MLF10P\_3\_05MM\_B  
REV3  
10-12-10



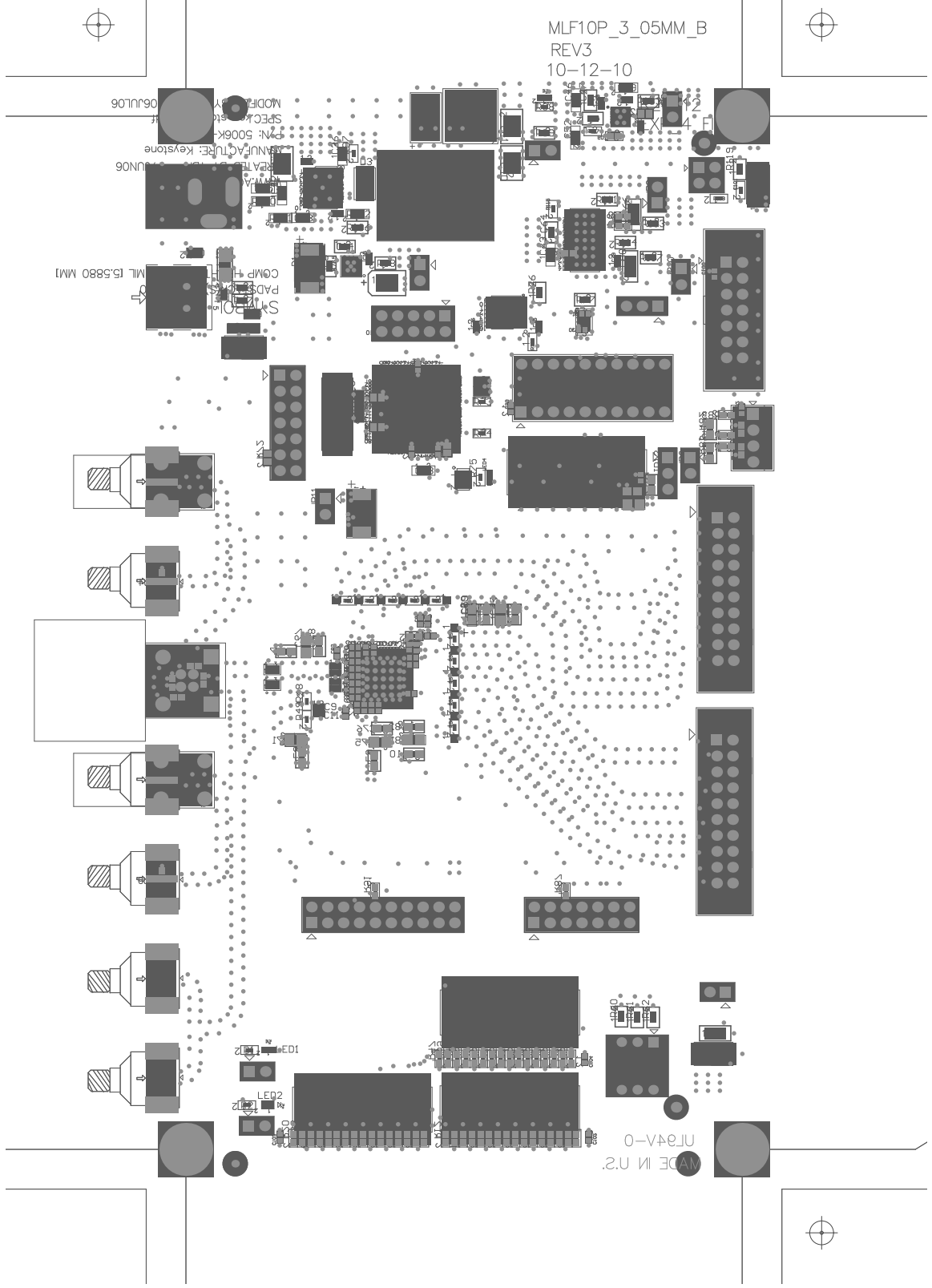
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SPEC. # 51006  
P/N: 5006K  
MANUFACTURE: Keystone  
DATE: 10/12/10  
UNN06

COMP ML (5.5880 MM)  
PADS  
SMT

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MLF10P\_3\_05MM\_B  
REV3  
10-12-10



MODIFIED BY  
SPEC. # 5006K  
PART NUMBER: Keystone  
UNNUN06

COMP ML (5.5880 MM)  
PADS  
SMT

UL94V-0  
MADE IN U.S.



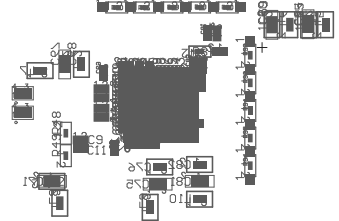
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10-12-10



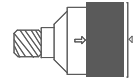
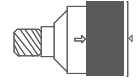
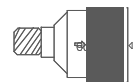
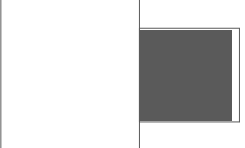
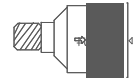
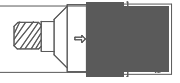
MODIFIED BY  
P/N: 5006K  
SPEC: 0506  
06JUL06

MANUFACTURE: Keystone  
REATER SYSTEM JUN06

SYMBOLS  
PADS COMP H  
ML (5.5880 MM)



LED1  
LED2



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